

SANYO Semiconductors

DATA SHEET



N-Channel Silicon MOSFET **2SK2531** — General-Purpose Switching Device **Applications**

Features

- · Low ON-resistance.
- · High-speed diode.
- · Enables simplified fabrication, high-density mounding, and miniaturization in end products due to the surface mountable package.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		250	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current	ID		6	A
Drain Current (Pulse)	IDP	PW≤10µs, duty cycle≤1%	24	A
Allowable Power Dissipation	PD	Tc=25°C	30	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			11
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	250			V
Gate-to-Source Breakdown Voltage	V(BR)GSS	IG= ±100µA, V _{DS} =0V	±30			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =250V, V _{GS} =0V			1.0	mA
Gate-to-Source Leakage Current	IGSS	$V_{GS}=\pm 25V, V_{DS}=0V$			±10	μΑ
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	2.0		3.0	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =3A	2.5	4.0		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)	ID=3A, VGS=10V		600	800	mΩ

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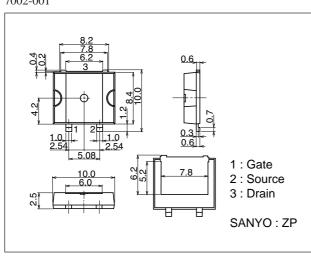
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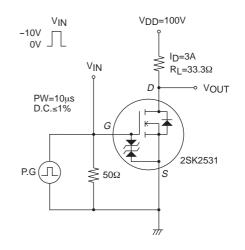
Continued from preceding page. Ratings Parameter Symbol Conditions Unit min typ max Input Capacitance Ciss VDS=20V, f=1MHz 420 pF Output Capacitance Coss VDS=20V, f=1MHz 95 pF Reverse Transfer Capacitance Crss VDS=20V, f=1MHz 30 pF See specified Test Circuit. Turn-ON Delay Time td(on) 12 ns Rise Time See specified Test Circuit. tr 15 ns Turn-OFF Delay Time td(off) See specified Test Circuit. 65 ns Fall Time See specified Test Circuit. 55 tf ns Diode Forward Voltage IS=6A, VGS=0V 1.0 1.5 V VSD Ig=6A, di / dt=100A / µs Diode Reverse Recovery Time 100 trr ns

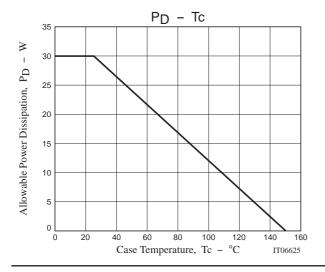
Package Dimensions

unit : mm (typ) 7002-001



Switching Time Test Circuit





Note on usage : Since the 2SK2531 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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